



Steady-State Thermal Analysis of CLIC module T0#2

Case: Two-beam module 50Hz vs. 100Hz

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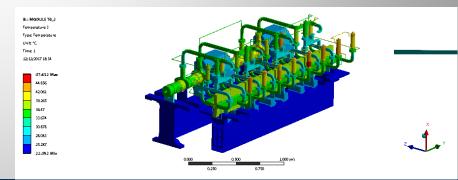
Thermal analysis of CLIC module

Aim of the Finite Element Method (FEM) simulation is to study heat distribution and dissipation in CLIC module T0#2.

Thermal gradients originate from several sources: RF structures produce heat, components are cooled by water and air flow, ambient temperature varies

The modelling is done using ANSYS 17.2 Workbench. The FEM simulation of includes:

- 3D CAD geometry
- Steady-state thermal analysis (followed by Static structural analysis)
- Isotropic materials: OFE copper, aluminium, stainless steel, SiC
- Thermal loads
- Ambient temperature
- Thermal fluid (water)
- Convection, radiation, conduction

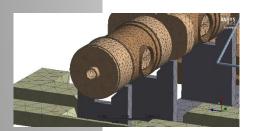


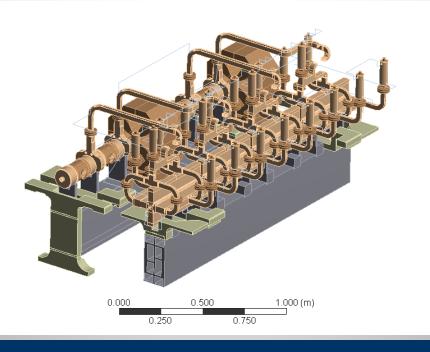


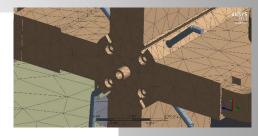
Heat-to-air simulation

Finite element model and boundary conditions

Geometry: After deleting, suppressing, and simplifying; 360 parts Contacts: Around 600 (bonded) contacts between parts Mesh: 1.3 million nodes, 0.7 million elements → Computation time with ANSYS remote solver (MECH-016c-128GB): Thermal analysis – 20 min







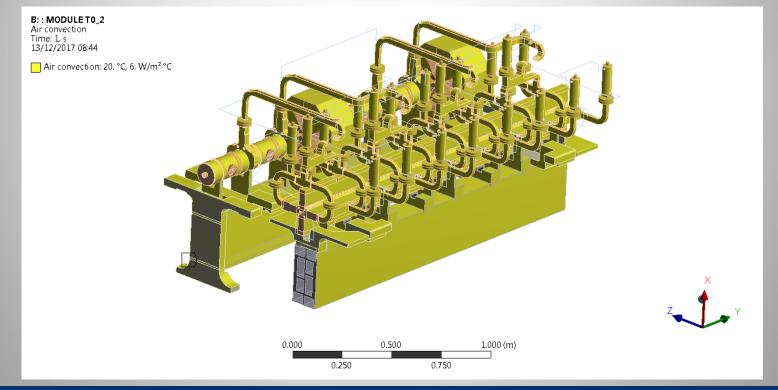




Air convection

Convection to air

- Constant heat transfer coefficient 6 W/(m² °C), total area 11.32 m²
- This has been estimated based on horizontal air flow of 0.4 m/s (CFD simulations, E. Lam)



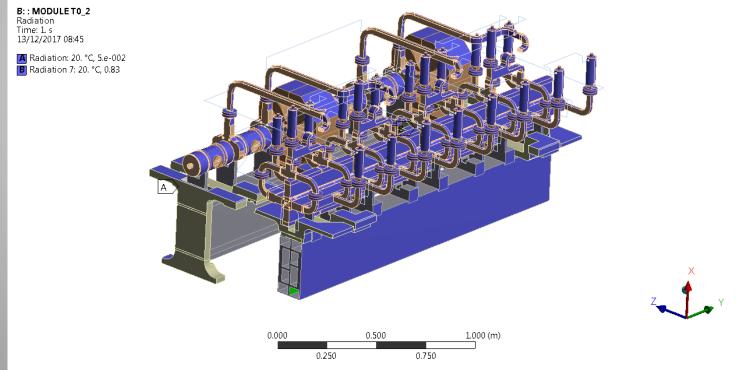




Thermal radiation

Radiation to surrounding space (ambient temperature):

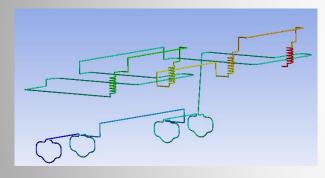
- Emissivity for copper, aluminium and stainless steel (0.05) and SiC (0.83)
- No surface-to-surface effects
- Area 4.87 m² (components) + 1.47 m² (girders) = 6.34 m²



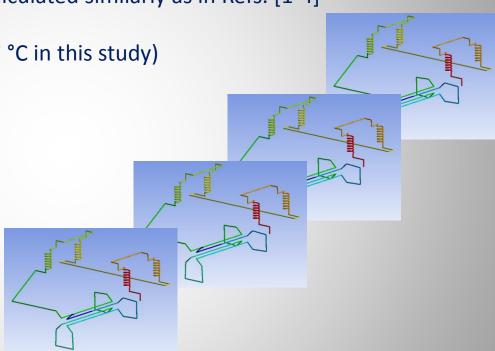


Water cooling

- 5 separate cooling circuits
- Water heat transfer coefficient is calculated similarly as in Refs. [1-4]
- Flow can be varied
- Inlet temperature can be varied (27 °C in this study)



2 double PETS and 4 RF loads in series (these RF loads are not active in this study)



SAS and 4CLs in series



Heat-to-air simulation



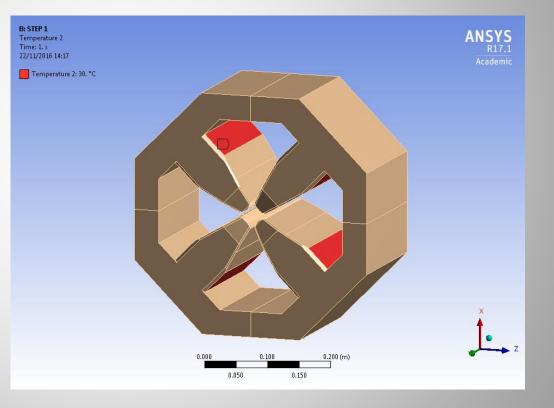
Heat loads

DBQ:

- Coils are excluded
- Cooling of the coils is assumed very effective:

 Convection with HTC = 5000
(around the same magnitude than water cooling in SAS and PETS) is set to the surfaces where coils should be

- Heat load 171 W



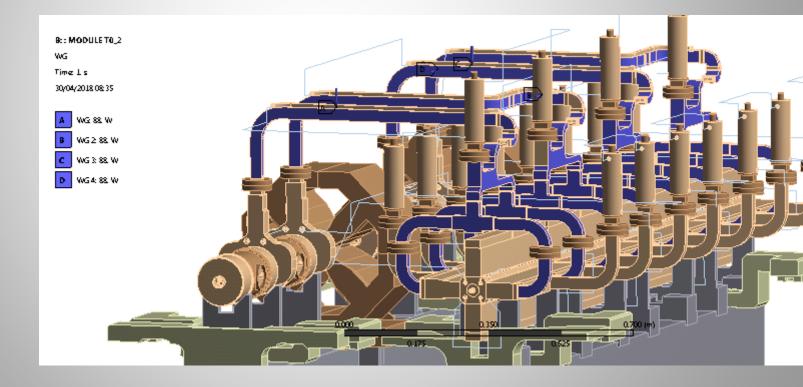




Heat loads

Waveguides:

- WG network connecting DB and MB is cooled from the top
- Heat 88 W per network (@50Hz)







Heat loads

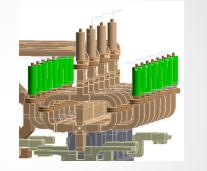
Components are heated with heat elements.

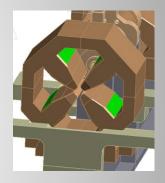
Assume: increasing 50Hz to 100Hz doubles the heat generation in RF components

Two cases studied here:

RF@50Hz, Unloaded

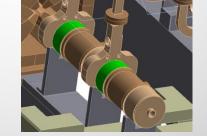
		Heating power (W)	
CL	16x	168	2688
PETS	4x	11	44
SAS	4x	780	3120
DBQ	2x	171	342
WG	4x	88	352
Total			6546

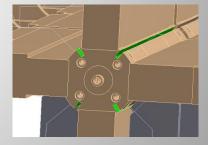




RF@100Hz, Unloaded

		Heating power (W)	
CL	16x	336	5376
PETS	4x	22	88
SAS	4x	1560	6240
DBQ	2x	171	342
WG	4x	176	704
Total			12750





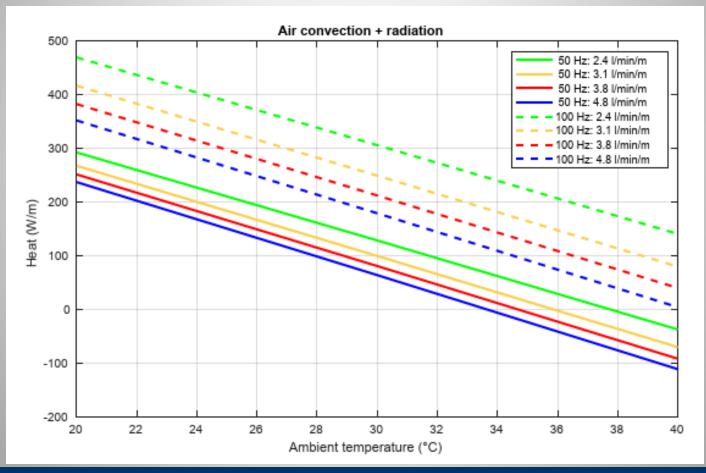
*simulation is done with 2m long model but results divided by 2.35m





Results: 50Hz vs 100Hz

Heat to air: for different water flows

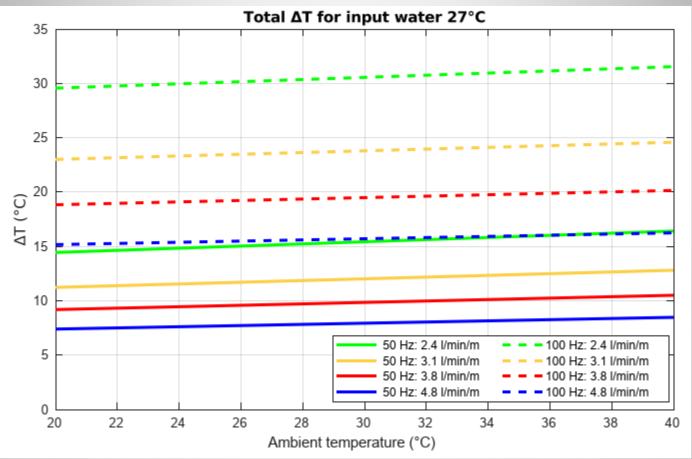






Results: 50Hz vs 100Hz

Delta T: for different water flows





Heat-to-air simulation



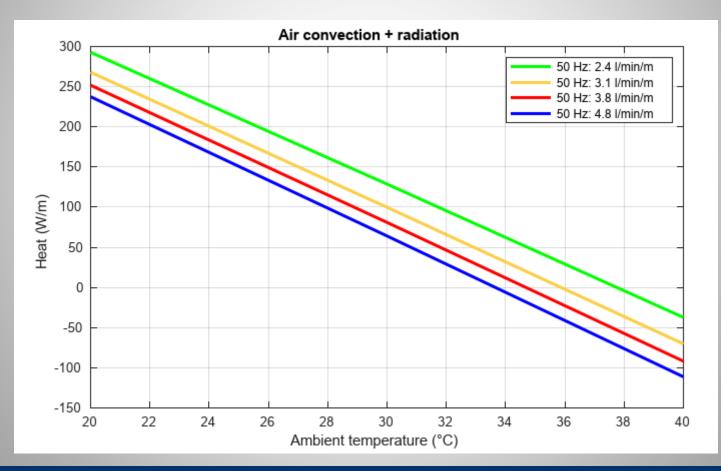
Extras: plots for 50Hz and 100Hz separately





Results: 50Hz

Heat to air: for different water flows

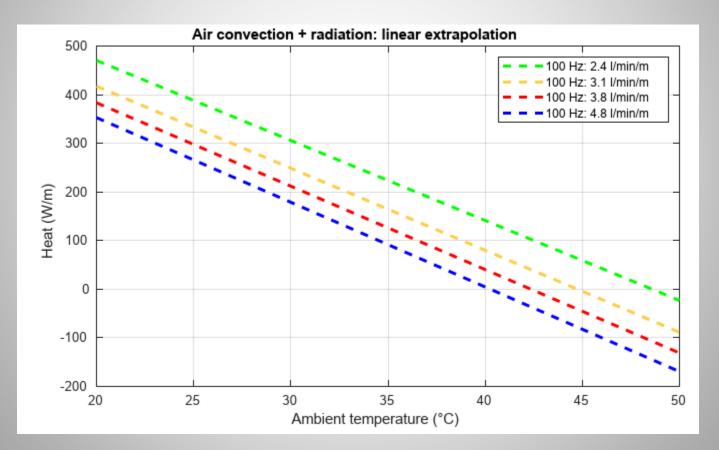






Results: 100Hz (linear extrapolation 40...50°C)

Heat to air: for different water flows

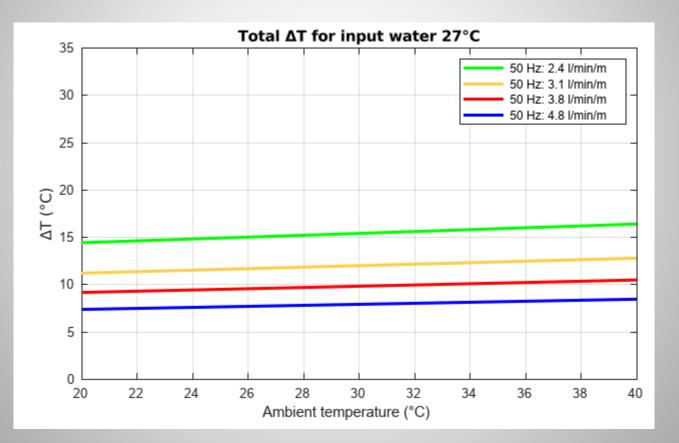






Results: 50Hz

Delta T: for different water flows

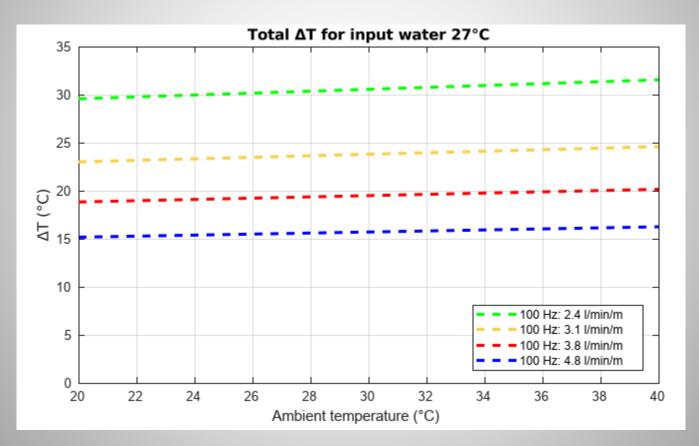






Results: 100Hz

Delta T: for different water flows







References:

[1] Kortelainen, L., Thermo-mechanical modelling and experimental validation of CLIC prototype module type 0, Master's thesis, Department of Mechanical Engineering, University of Oulu, Finland, 2013

[2] Nousiainen, R. *et al.*, Studies on the Thermo-Mechanical behaviour of the CLIC Two-Beam Module. Linear Accelerator Conference 2010, Tsukuba, Japan, 2010

[3] Raatikainen, R., Modelling of the thermo-mechanical behavior of the two-beam module for the compact linear collider, Master's thesis, Department of Mechanics and Design, Tampere University of Technology, Finland, 2011

[4] Moilanen, A., Aicheler, M., Vamvakas, A., Vainola, J., Doebert, S., Finite Element Model for Thermal-Structural analysis of CLIC Lab Module type 0#2, CERN-ACC-2017-0016, CLIC-Note-1073, 2017